

# MJ P-Channel Enhancement Mode Power MOSFET

## Description

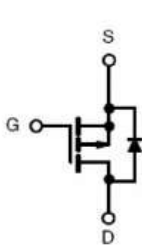
The MJ60P18AK uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. This device is well suited for use as a load switch or in PWM applications.

## General Features

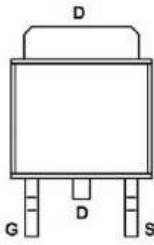
- ◆  $V_{DS} = -60V, I_D = -18A$   
 $R_{DS(ON)} < 65m\Omega @ V_{GS} = -10V$   
 $R_{DS(ON)} < 85m\Omega @ V_{GS} = -4.5V$
- ◆ High density cell design for ultra low  $R_{dson}$
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- ◆ Excellent package for good heat dissipation

## Application

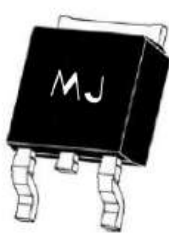
- ◆ High side switch for full bridge converter
- ◆ DC/DC converter for LCD display



Schematic diagram



Marking and pin assignment



TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

## Package Marking and Ordering Information

| Device Marking | Device    | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| MJ60P18AK      | MJ60P18AK | TO-252-2L      | -         | -          | -        |

## Absolute Maximum Ratings (Tc =25 °Cunless otherwise noted)

| Parameter   | Symbol                | Limit      | Unit |
|---|-----------------------|------------|------|
| Drain-Source Voltage                              | $V_{DS}$              | -60        | V    |
| Gate-Source Voltage                               | $V_{GS}$              | ±20        | V    |
| Drain Current-Continuous                          | $I_D$                 | -18        | A    |
| Drain Current-Continuous( $T_C = 100^{\circ}C$ )  | $I_{D(100^{\circ}C)}$ | -12.7      | A    |
| Pulsed Drain Current                              | $I_{DM}$              | -72        | A    |
| Maximum Power Dissipation                         | $P_D$                 | 60         | W    |
| Derating factor                                   |                       | 0.4        | W/°C |
| Single pulse avalanche energy <sup>(Note 5)</sup> | $E_{AS}$              | 50         | mJ   |
| Operating Junction and Storage Temperature Range  | $T_J, T_{STG}$        | -55 To 175 | °C   |

## Thermal Characteristic

|   |                 |     |      |
|---|-----------------|-----|------|
| Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup> | $R_{\theta JC}$ | 2.5 | °C/W |
|---|-----------------|-----|------|

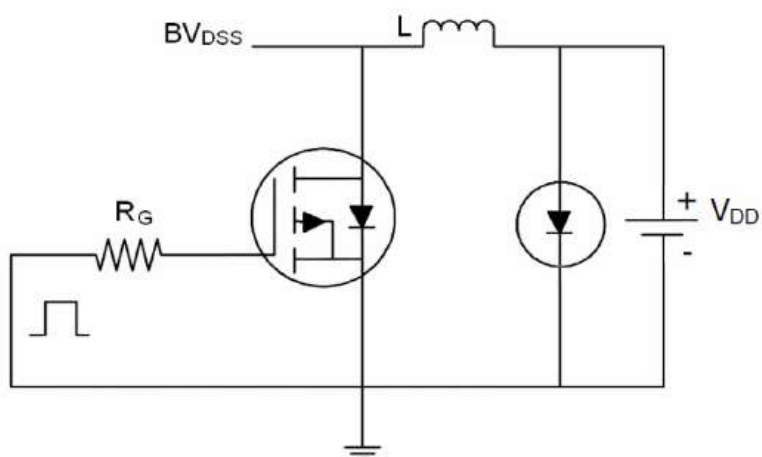
Electrical Characteristics (T<sub>c</sub> =25°Cunless otherwise noted)

| Parameter   | Symbol              | Condition   | Min | Typ    | Max  | Unit |
|---|---------------------|---|-----|--------|------|------|
| Off Characteristics                               |                     |   |     |        |      |      |
| Drain-Source Breakdown Voltage                    | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =-250μA  | -60 | -      | -    | V    |
| Zero Gate Voltage Drain Current                   | I <sub>DSS</sub>    | V <sub>DS</sub> =-60V,V <sub>GS</sub> =0V   | -   | -      | -1   | μA   |
| Gate-Body Leakage Current                         | I <sub>GSS</sub>    | V <sub>DS</sub> =±20V,V <sub>GS</sub> =0V   | -   | -      | ±100 | nA   |
| On Characteristics <small>(Note 3)</small>        |                     |   |     |        |      |      |
| Gate Threshold Voltage                            | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA                                | -1  | -1.5   | -2.2 | V    |
| Drain-Source On-State Resistance                  | R <sub>DS(ON)</sub> | V <sub>GS</sub> =-10V, I <sub>D</sub> =-12A   | -   | 49     | 65   | mΩ   |
|   |                     | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-8A   | -   | 58     | 85   | mΩ   |
| Forward Transconductance                          | g <sub>FS</sub>     | V <sub>DS</sub> =-5V,I <sub>D</sub> =-12A   | -   | 10     | -    | S    |
| Dynamic Characteristics <small>(Note 4)</small>   |                     |   |     |        |      |      |
| Input Capacitance                                 | C <sub>iss</sub>    | V <sub>DS</sub> =-30V,V <sub>GS</sub> =0V<br>F=1.0MHz                                   | -   | 1630.7 | -    | PF   |
| Output Capacitance                                | C <sub>oss</sub>    |   | -   | 90.6   | -    | PF   |
| Reverse Transfer Capacitance                      | C <sub>rss</sub>    |   | -   | 77.3   | -    | PF   |
| Switching Characteristics <small>(Note 4)</small> |                     |   |     |        |      |      |
| Turn-on Delay Time                                | t <sub>d(on)</sub>  | V <sub>DD</sub> =-30V, R <sub>L</sub> =1.5Ω<br>V <sub>GS</sub> =-10V,R <sub>G</sub> =3Ω | -   | 11     | -    | nS   |
| Turn-on Rise Time                                 | t <sub>r</sub>      |   | -   | 14     | -    | nS   |
| Turn-Off Delay Time                               | t <sub>d(off)</sub> |   | -   | 33     | -    | nS   |
| Turn-Off Fall Time                                | t <sub>f</sub>      |   | -   | 13     | -    | nS   |
| Total Gate Charge                                 | Q <sub>g</sub>      | V <sub>DS</sub> =-30V,I <sub>D</sub> =-12A<br>V <sub>GS</sub> =-10V                     | -   | 37.6   | -    | nC   |
| Gate-Source Charge                                | Q <sub>gs</sub>     |   | -   | 4.3    | -    | nC   |
| Gate-Drain Charge                                 | Q <sub>gd</sub>     |   | -   | 7.2    | -    | nC   |
| Drain-Source Diode Characteristics                |                     |   |     |        |      |      |
| Diode Forward Voltage <small>(Note 3)</small>     | V <sub>SD</sub>     | V <sub>GS</sub> =0V,I <sub>S</sub> =-12A  | -   | -      | -1.2 | V    |
| Diode Forward Current <small>(Note 2)</small>     | I <sub>S</sub>      |   | -   | -      | -18  | A    |
| Reverse Recovery Time                             | t <sub>rr</sub>     | T <sub>J</sub> =25°C, I <sub>F</sub> =-12A<br>di/dt=-100A/μs <small>(Note 3)</small>    | -   | 35     | -    | nS   |
| Reverse Recovery Charge                           | Q <sub>rr</sub>     |   | -   | 38     | -    | nC   |
| Forward Turn-On Time                              | t <sub>on</sub>     | Intrinsic turn-on time is negligible(turn-on is dominated by LS+LD)                     |     |        |      |      |

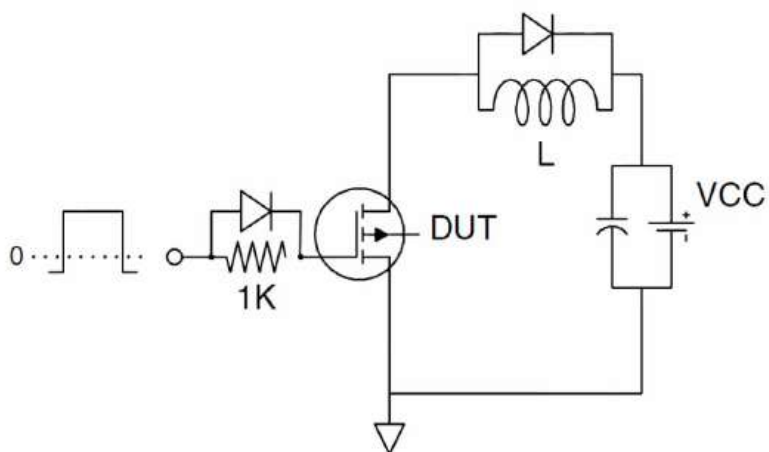
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
- ④ Guaranteed by design, not subject to production
- ⑤ EAS condition: T<sub>J</sub>=25°C, V<sub>DD</sub>=-30V,V<sub>G</sub>=-10V,L=0.5mH,R<sub>G</sub>=25Ω

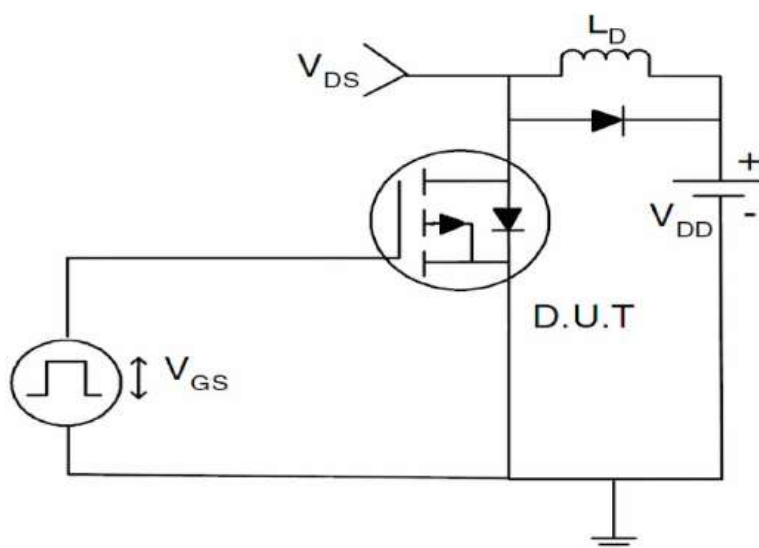
# Test circuit



EAS test Circuit

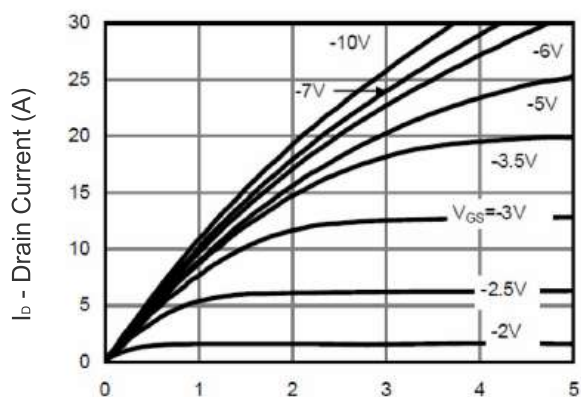


Gate charge test Circuit



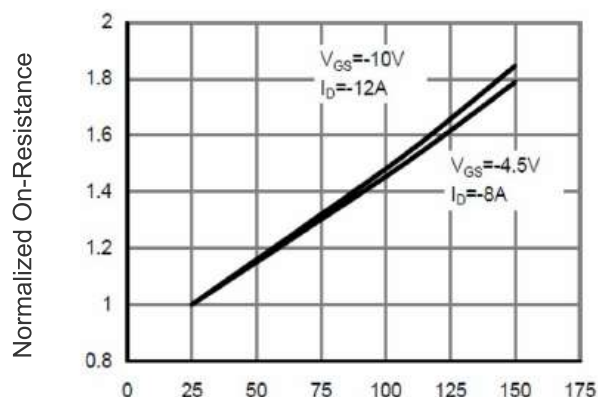
Switch Time Test Circuit

# Typical Electrical and Thermal Characteristics (Curves)



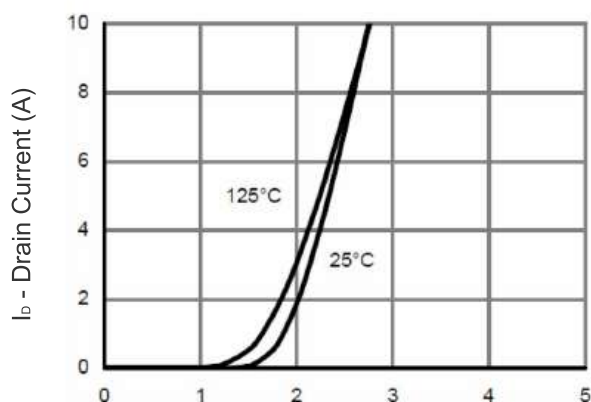
Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



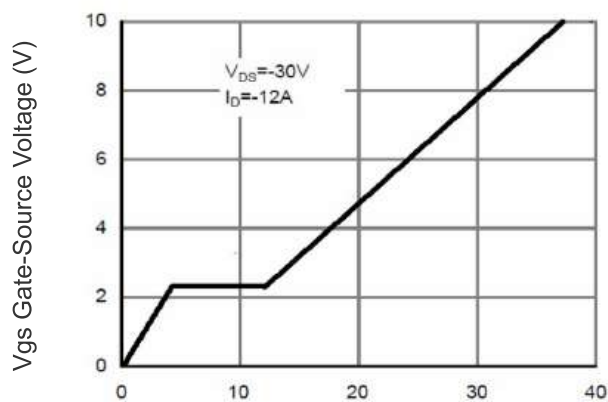
Tj -Junction Temperature(°C)

Figure 4 Rdson-Junction Temperature



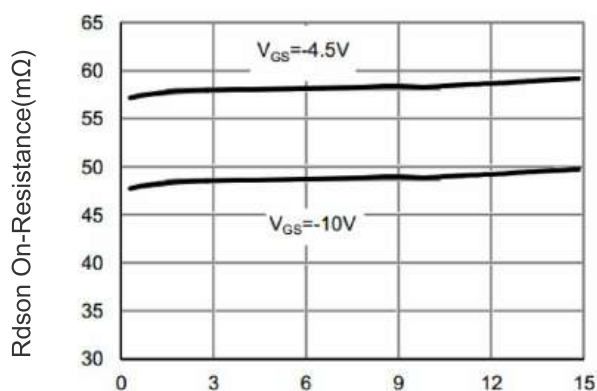
Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics



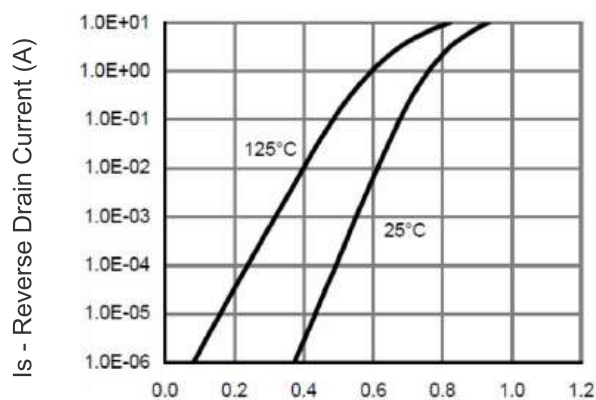
Qg Gate Charge (nC)

Figure 5 Gate Charge



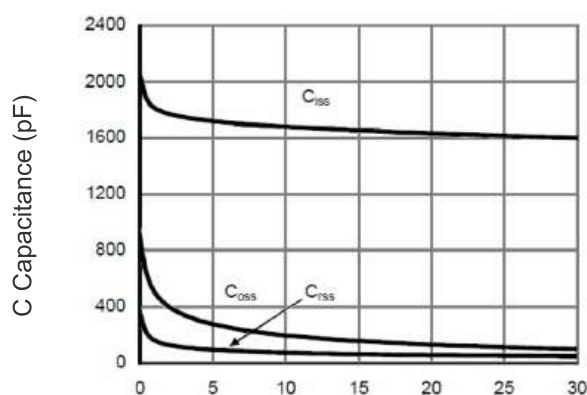
Id - Drain Current (A)

Figure 3 Rdson- Drain Current

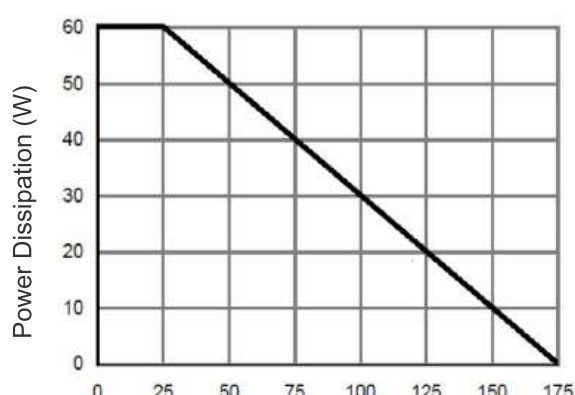


Vsd Source-Drain Voltage (V)

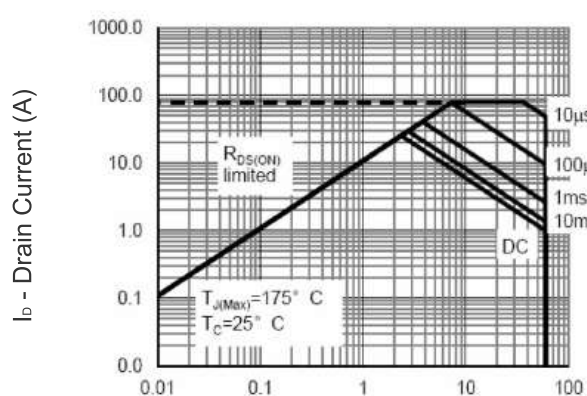
Figure 6 Source- Drain Diode Forward



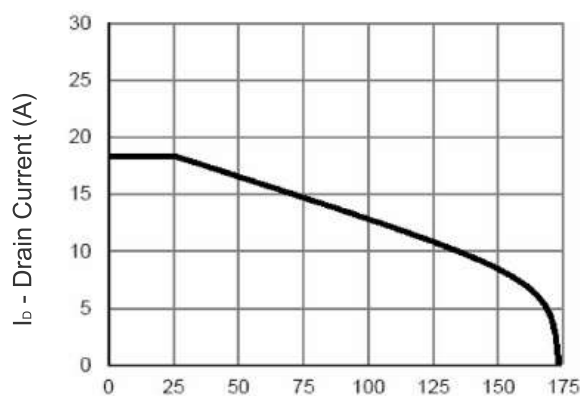
-Vds Drain-Source Voltage (V)  
Figure 7 Capacitance vs Vds



TJ -Junction Temperature(°C)  
Figure 9 Power De-rating



Vds Drain-Source Voltage (V)  
Figure 8 Safe Operation Area



TJ -Junction Temperature(°C)  
Figure 10 ID Current De-rating

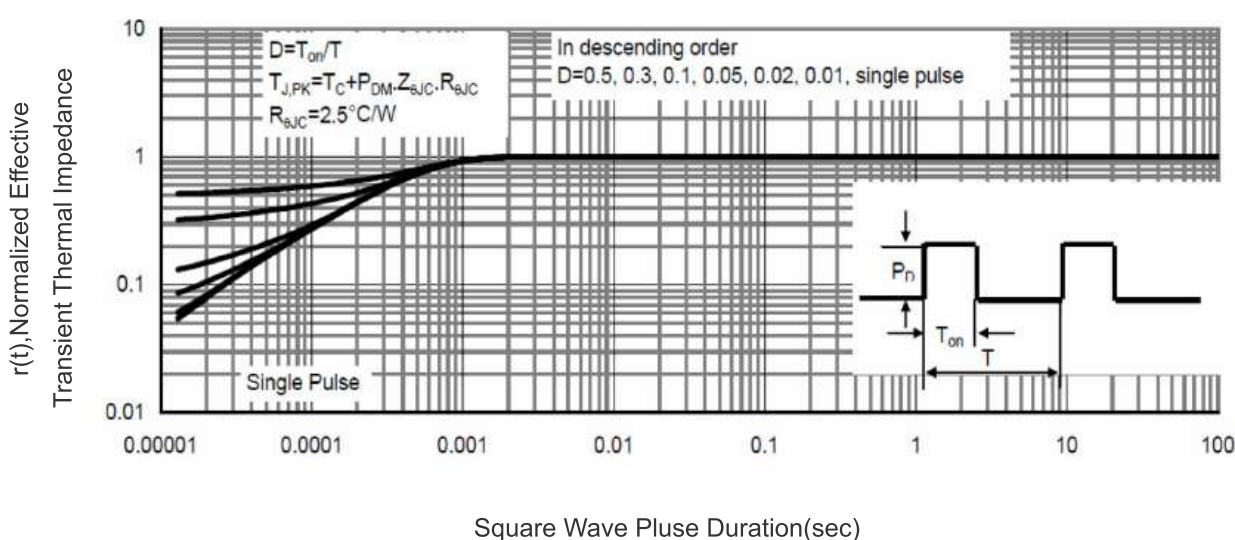
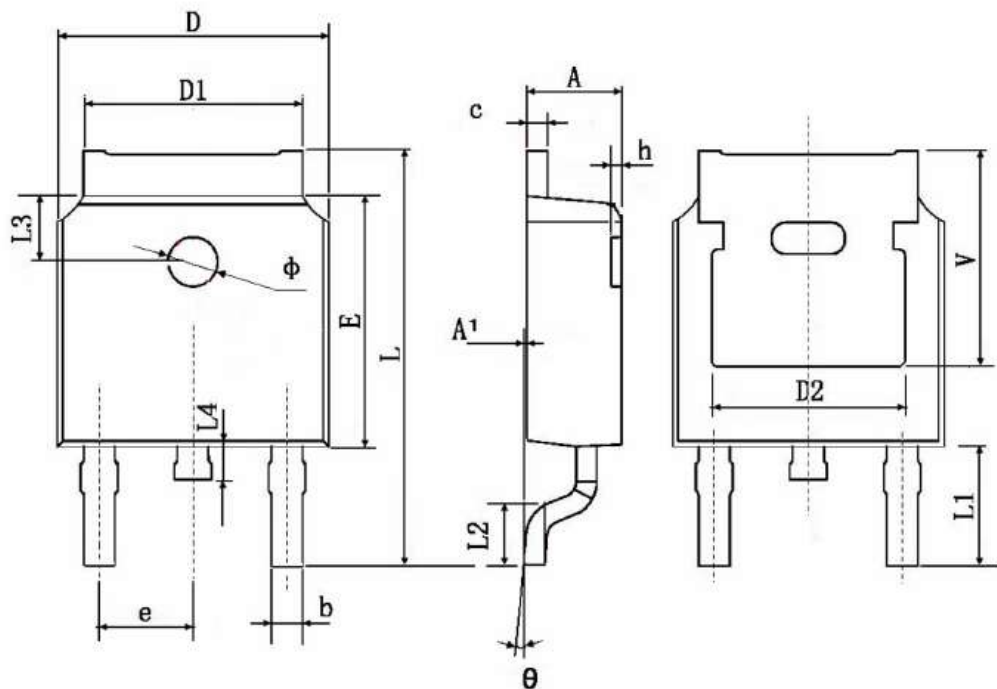


Figure 11 Normalized Maximum Transient Thermal Impedance

# TO-252 Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |
| b      | 0.660                     | 0.860  | 0.026                | 0.034 |
| c      | 0.460                     | 0.580  | 0.018                | 0.023 |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2     | 4.830 TYP.                |        | 0.190 TYP.           |       |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |
| e      | 2.186                     | 2.386  | 0.086                | 0.094 |
| L      | 9.800                     | 10.400 | 0.386                | 0.409 |
| L1     | 2.900 TYP.                |        | 0.114 TYP.           |       |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3     | 1.600 TYP.                |        | 0.063 TYP.           |       |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |
| Φ      | 1.100                     | 1.300  | 0.043                | 0.051 |
| θ      | 0°                        | 8°     | 0°                   | 8°    |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |
| V      | 5.350 TYP.                |        | 0.211 TYP.           |       |



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